ABSOCIATION CONNECTING ELECTROWICS INDUSTRIES OF COpyright 2005. International and P	IPC, Bannockt	urn, Illinois. A	ll rights reserved un ntions.	nder both	This docum level parts, t	ent is a declar the declaratio	ation of the s	substances es all lowe	within the manu r level materials	facturer listed for which the	d item. I e manuf	Note: if th acturer ha	e item is an ass s engineering i	sembly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Response Date*						
onsemi												2023-06-08			
Contact Name T			Title - Contact			Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com						
Authorized Representative*	Title - Representative			Phone - Representative*				Email	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Da	ate Version	ı 1	Manufacturing Site		Weig	nt*	UOM	Unit Type	
	ESDM10	ESDM1031MX4T5G Isolated		solated X4DFN Vrwm=3.3V		2023-06-08]	MY1		0.054	7	mg	Each	
Manufacturing Proccess Inform	ation												<u>.</u>		
Terminal Plating / Grid Array M	ng / Grid Array Material Terminal Base		Alloy J	J-STD-020 MSL Rating		Peak Process Body Ter		Femperatu	erature Max Time at Peak T		mperature Number of Reflow Cycles		es		
Sn alloys with no Bi or Zn excluding SnAgCu		CU Alloy 1				260		С	30 seco		conds 3				
Comments															
evel 1 - maximum time at peak tempera	ture during sol	dering is 10-3	0 seconds												
or more information regarding materia	al composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.042	mg	Supplier	Silicon (Si)	7440-21-3		0.042	mg	
Mold Compound-Black	0.0021	mg	Supplier	Hexahydromethylphthalic anhydride	25550-51-0		0.0003	mg	
			Supplier	1,6-Bis(2,3-epoxypropoxy)naphthalene	27610-48-6		0.0001	mg	
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.0001	mg	
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0016	mg	
			Supplier	Carbon Black (C)	1333-86-4		0	mg	
Plating	0.0104	mg	Supplier	Silver (Ag)	7440-22-4		0.0003	mg	
			Supplier	Tin (Sn)	7440-31-5		0.0073	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0028	mg	
Under Bump Metal	2.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0002	mg	